

# **Excellent Integrated System Limited**

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

STMicroelectronics STTH9012TV1

For any questions, you can email us directly: <a href="mailto:sales@integrated-circuit.com">sales@integrated-circuit.com</a>





## STTH9012TV

## Ultrafast recovery - 1200 V diode

#### Main product characteristics

I <sub>F(AV)</sub>	2 x 45 A
V <sub>RRM</sub>	1200 V
T <sub>j</sub>	150° C
V <sub>F</sub> (typ)	1.20 V
t <sub>rr</sub> (typ)	50 ns

#### Features and benefits

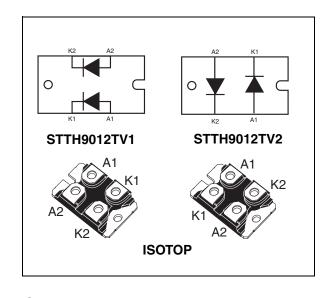
- Ultrafast, soft recovery
- Very low conduction and switching losses
- High frequency and/or high pulsed current operation
- High reverse voltage capability
- High junction temperature
- Insulated package:
  Electrical insulation = 2500 V<sub>RMS</sub>
  Capacitance = 45 pF

## **Description**

The high quality design of this diode has produced a device with low leakage current, regularly reproducible characteristics and intrinsic ruggedness. These characteristics make it ideal for heavy duty applications that demand long term reliability.

Such demanding applications include industrial power supplies, motor control, and similar mission-critical systems that require rectification and freewheeling. These diodes also fit into auxiliary functions such as snubber, bootstrap, and demagnetization applications.

The improved performance in low leakage current, and therefore thermal runaway guard band, is an immediate competitive advantage for this device.



#### **Order codes**

Part Number	Marking
STTH9012TV1	STTH9012TV1
STTH9012TV2	STTH9012TV2

March 2006 Rev 1 1/8

8



Characteristics STTH9012TV

#### 1 Characteristics

Table 1. Absolute ratings (limiting values per diode at 25° C, unless otherwise specified)

Symbol	Parameter			Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage	Repetitive peak reverse voltage			V
I <sub>F(RMS)</sub>	RMS forward current			150	Α
I <sub>F(AV)</sub>	Average forward current, $\delta = 0.5$	Average forward current, $\delta = 0.5$ $T_c = 75^{\circ}$ C per diode			Α
I <sub>FRM</sub>	Repetitive peak forward current	t <sub>p</sub> = 5 μs, F = 5 kHz square		600	Α
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms Sinusoidal	420	Α	
T <sub>stg</sub>	Storage temperature range			-65 to + 150	°C
T <sub>j</sub>	Maximum operating junction temperature			150	°C

Table 2.Thermal parameters

Symbol	Parameter		Value	Unit
D	Junction to case	Per diode 0.74		
$R_{th(j-c)}$	Total	Total	0.42	°C/W
R <sub>th(c)</sub>	Coupling thermal resistance		0.1	

When the diodes are used simultaneously:

 $\Delta T_{j(diode1)} = P_{(diode1)} \times R_{th(j-c)} \text{ (per diode)} + P_{(diode2)} \times R_{th(c)}$ 

Table 3. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
I <sub>R</sub> <sup>(1)</sup>	Povorco logizado gurrant	T <sub>j</sub> = 25° C	V - V			30	
'R` ′	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 125° C	$V_R = V_{RRM}$		30	300	μA
		T <sub>j</sub> = 25° C				2.10	
V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	T <sub>j</sub> = 125° C	I <sub>F</sub> = 45 A		1.25	1.90	V	
		T <sub>j</sub> = 150° C			1.20	1.80	

- 1. Pulse test:  $t_p$  = 5 ms,  $\delta$  < 2 %
- 2. Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2 %

To evaluate the conduction losses use the following equation:

 $P = 1.40 \times I_{F(AV)} + 0.0089 I_{F}^{2}_{(RMS)}$ 





STTH9012TV Characteristics

Table 4. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Тур	Max.	Unit
		$I_F = 1 \text{ A, } dI_F/dt = -50 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$			125	
t <sub>rr</sub>	Reverse recovery time	$I_F = 1 \text{ A, } dI_F/dt = -100 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$		63	85	ns
	$I_F = 1 \text{ A, } dI_F/dt = -200 \text{ A/}\mu\text{s,}$ $V_R = 30 \text{ V, } T_j = 25^{\circ} \text{ C}$		50	70		
I <sub>RM</sub>	Reverse recovery current	$I_F = 45 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 600 \text{ V}, T_j = 125^{\circ} \text{ C}$		32	45	Α
S	Softness factor	$I_F = 45 \text{ A}, dI_F/dt = -200 \text{ A/}\mu\text{s}, \ V_R = 600 \text{ V}, T_j = 125^{\circ} \text{ C}$		1		
t <sub>fr</sub>	Forward recovery time	$I_F = 45 \text{ A}$ $dI_F/dt = 100 \text{ A/µs}$ $V_{FR} = 1.5 \text{ x } V_{Fmax}, T_j = 25^{\circ} \text{ C}$			700	ns
V <sub>FP</sub>	Forward recovery voltage	$I_F = 45 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s},$ $T_j = 25^{\circ} \text{ C}$		4.5		V

Figure 1. Conduction losses versus average current

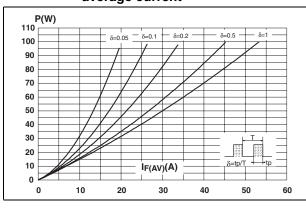
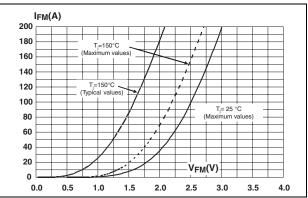


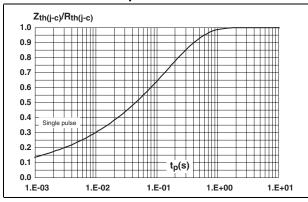
Figure 2. Forward voltage drop versus forward current



Characteristics STTH9012TV

Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

Figure 4. Peak reverse recovery current versus dl<sub>F</sub>/dt (typical values)



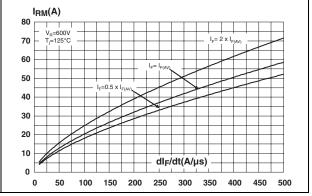
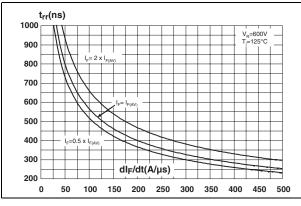


Figure 5. Reverse recovery time versus dl<sub>F</sub>/dt (typical values)

Figure 6. Reverse recovery charges versus dl<sub>F</sub>/dt (typical values)



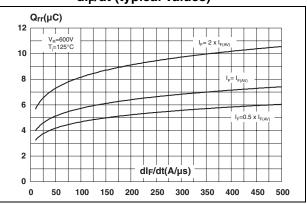
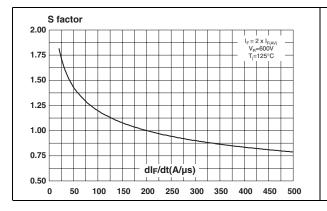
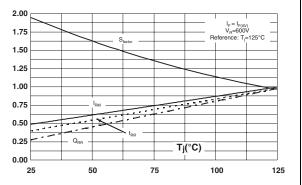


Figure 7. Softness factor versus dl<sub>F</sub>/dt (typical values)

Figure 8. Relative variations of dynamic parameters versus junction temperature



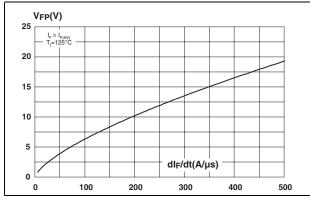




STTH9012TV **Characteristics** 

Figure 9. Transient peak forward voltage versus dl<sub>F</sub>/dt (typical values)

Figure 10. Forward recovery time versus dl<sub>F</sub>/dt (typical values) t<sub>fr</sub>(ns) 1400 T:=125°C 1200



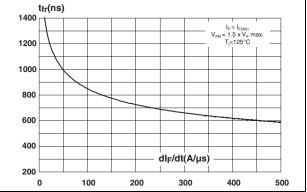
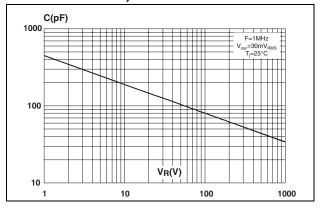


Figure 11. Junction capacitance versus reverse voltage applied (typical values)





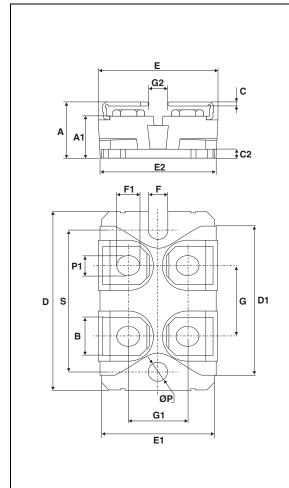
Package information STTH9012TV

## 2 Package information

Epoxy meets UL94, V0

Cooling method: by conduction (C)

Table 5. ISOTOP dimensions



	DIMENSIONS				
REF.	Millin	neters	Inc	hes	
	Min.	Max	Min.	Max.	
Α	11.80	12.20	0.465	0.480	
A1	8.90	9.10	0.350	0.358	
В	7.8	8.20	0.307	0.323	
С	0.75	0.85	0.030	0.033	
C2	1.95	2.05	0.077	0.081	
D	37.80	38.20	1.488	1.504	
D1	31.50	31.70	1.240	1.248	
Е	25.15	25.50	0.990	1.004	
E1	23.85	24.15	0.939	0.951	
E2	24.80 typ.		0.976 typ.		
G	14.90	15.10	0.587	0.594	
G1	12.60	12.80	0.496	0.504	
G2	3.50	4.30	0.138	0.169	
F	4.10	4.30	0.161	0.169	
F1	4.60	5.00	0.181	0.197	
Р	4.00	4.30	0.157	0.69	
P1	4.00	4.40	0.157	0.173	
S	30.10	30.30	1.185	1.193	

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.





STTH9012TV Ordering information

# 3 Ordering information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
STTH9012TV1	STTH9012TV1	ISOTOP	27 g	10	Tube
STTH9012TV2	STTH9012TV2	ISOTOP	27 g	10	Tube

## 4 Revision history

Date	Revision	Description of Changes
02-Mar-2006	1	First issue.





# Distributor of STMicroelectronics: Excellent Integrated System Limited Datasheet of STTH9012TV1 - DIODE MODULE 1.2KV 45A ISOTOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

STTH9012TV

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZE REPRESENTATIVE OF ST, ST PRODUCTS ARE NOT DESIGNED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS, WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

